TOSHIBA OR8GU41

TOSHIBA RECTIFIER SILICON DIFFUSED TYPE

0 R 8 G U 4 1

HIGH SPEED RECTIFIER APPLICATIONS (FAST RECOVERY)

• Average Forward Current : I_{F (AV)}=0.8A (Ta=40°C)

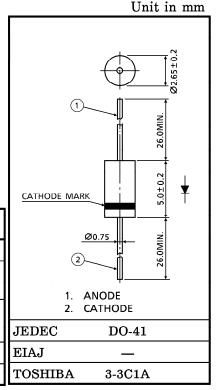
• Repetitive Peak Reverse Voltage : V_{RRM}=200~400V

• Reverse Recovery Time : t_{rr}=100ns (Max.)

• Plastic Mold Type.

MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Repetitive Peak Reverse Voltage	v_{RRM}	400	V	
Average Forward Current (Ta=40°C)	I _{F (AV)}	0.8	A	
Peak One Cycle Surge Forward		30 (50Hz)	A	
Current (Non-Repetitive)	rent (Non-Repetitive)	33 (60Hz)	A	
Junction Temperature	T_{j}	-40~150	$^{\circ}\mathrm{C}$	
Storage Temperature Range	$\mathrm{T}_{\mathrm{stg}}$	-40~150	°C	



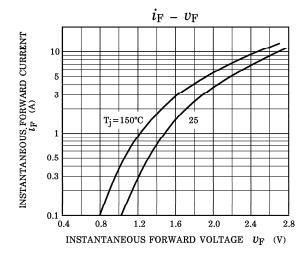
Weight: 0.3g

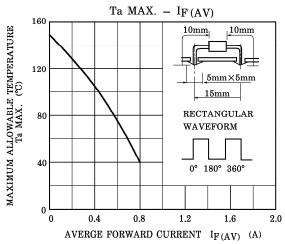
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

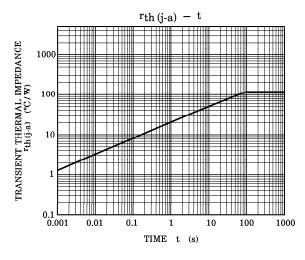
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	MAX.	UNIT
Peak Forward Voltage	$ m v_{FM}$	$I_{\text{FM}} = 1.0 A$	_	1.5	V
Repetitive Peak Reverse Current	$I_{ m RRM}$	$V_{ m RRM}$ =400V	_	50	μ A
Reverse Recovery Time	$ m t_{rr}$	$I_{\rm F}$ =1.0A, di/dt=-30A/ μ s	_	100	ns
Forward Recovery Time	t_{fr}	$I_{\mathbf{F}} = 1.0 A$	_	200	ns
Thermal Resistance	R _{th (j-a)}	Junction to Ambient	_	115	°C/W
Thermal Resistance	$R_{ ext{th}\;(j-\ell)}$	Junction to Lead	_	45	°C/W

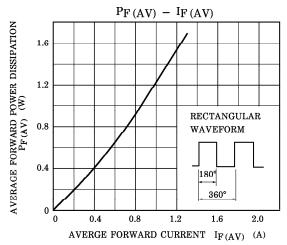
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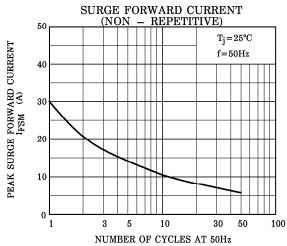
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